

## Data sheet

### HC50/U

### Through Hole Quartz Crystal (11.0 x 4.7 x 13.5 mm)

## FEATURES

- Wide frequency range
- High reliability by means of resistance weld hermetic seal
- Excellent aging characteristics
- High precision availability
- Applications: Telecommunication equipment, PC boards...



Parameter	min.	typ.	max.	Unit	Condition	
Frequency range	1.8432		176.0	MHz		
	Fundamental	1.8432	48.0	MHz	For higher frequencies in 7th overtone please consult FCD-Tech	
	3rd overtone	26.0	90.0	MHz		
	5th overtone	80.0	176.0	MHz		
Vibration mode	AT cut, fundamental, 3rd, 5th ovt					
Frequency stability						
	Initial tolerance @25°C		±30	ppm	Specify (see options)	
	vs. operating temperature range		±30	ppm	Specify (see options)	
	operating temperature range	-10		+60	°C	Specify (see options)
Equivalent Series Resistance (ESR)	See table 1					
Load Capacitance (CL)	Series or 8pF to 32pF (see options)					
Shunt Capacitance (Co)			7.0	pF		
Drive Level			1000	µW		
Aging		±5	±2	ppm	At 25°C, first year	
Insulation Resistance	500			MΩ	@ 100Vdc	
Enclosure (see drawing) (LxWxH)	HC50/U	11.0 x 4.7 x 13.5		mm		
	HC50/T	11.0 x 4.7 x 11.3		mm		
	HC50/T3	11.0 x 4.7 x 9.5		mm		
Packing	Bulk in bag					

### Ordering Code:

Version (H in mm)	Freq. Tolerance @ 25°C	Freq. Stability	Operating Temp. range	Load Capacitance	Mode	Frequency in MHz	ESR if other than STD
HC50/U = 13.5	05 = ± 5ppm	05 = ± 5ppm	D = -10° / +60°C	Please specify CL	F = Fundamental	Specify the	Specify a value
HC50/T = 11.3	10 = ± 10ppm	10 = ± 10ppm	E = 0° / +70°C	in pF or	3 = 3rd ovt	frequency in MHz	in Ω
HC50/T3 = 9.5	15 = ± 15ppm	15 = ± 15ppm	F = -20° / +70°C	S for series	5 = 5th ovt		
	20 = ± 20ppm	20 = ± 20ppm	G = -30° / +75°C				
	25 = ± 25ppm	25 = ± 25ppm	H = -30° / +85°C				
	30 = ± 30ppm	30 = ± 30ppm	K = -40° / +85°C				
	50 = ± 50ppm	50 = ± 50ppm					

Example: HC50/U-10-10-E-S-5-125.500MHz

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#### Outline Dimensions:

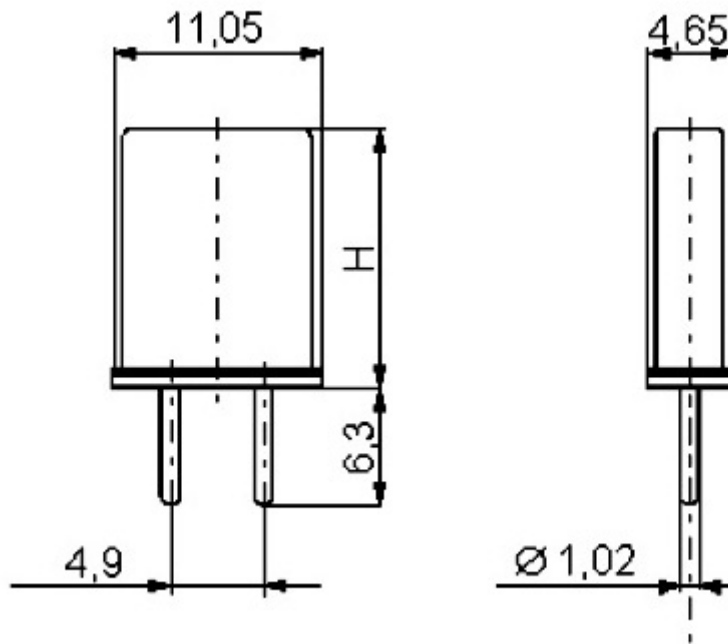


Table 1 : Standard ESR

Frequency	Mode	ESR
1.8432 MHz	Fundamental	500 $\Omega$ max.
2.0 ~ 2.9 MHz	Fundamental	350 $\Omega$ max.
3.0 ~ 3.1 MHz	Fundamental	200 $\Omega$ max.
3.2 ~ 3.9 MHz	Fundamental	150 $\Omega$ max.
4.0 ~ 4.4 MHz	Fundamental	100 $\Omega$ max.
4,5 ~ 4.9 MHz	Fundamental	80 $\Omega$ max.
5.0 ~ 6.9 MHz	Fundamental	50 $\Omega$ max.
7.0 ~ 9.9 MHz	Fundamental	35 $\Omega$ max.
10.0 ~ 48.0 MHz	Fundamental	25 $\Omega$ max.
26.0 ~ 90.0 MHz	3rd ovt	70 $\Omega$ max.
80.0 ~ 176.0 MHz	5th ovt	120 $\Omega$ max.

Type	Height (max.)
HC50/U	13.5mm
HC50/T	11.3mm
HC50/T3	9.5mm

#### Environmental conditions

Test	IEC 60068 Part ...	IEC 60679-1 clause ...	Test conditions (IEC)
Sealing tests (if applicable)	2-17	5.6.2	Gross leak: Test Qc, Fine leak: Test Qk
Solderability	2-20	5.6.3	Test Ta Method 1
Resistance to soldering heat	2-58		Test Td <sub>1</sub> Method 2 Test Td <sub>2</sub> Method 2
Shock*	2-27	5.6.8	Test Ea, 3 x per axes 100g, 6 ms half-sine pulse
Vibration, sinusoidal*	2-6	5.6.7.1	Test Fc, 30 min per axes, 10 Hz - 55 Hz 0,75mm; 55 Hz - 2 kHz, 10g
Vibration random *	2-64	5.6.7.3	Test Fdb
Endurance tests			
- ageing		5.7.1	30 days @ 85°C, OCXO @ 25°C
- extended aging		5.7.2	1000h, 2000h, 8000h @ 85°C

Rev. 2 dated 01-02-2013